

10007457-1

**IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE**

5 **Inventors:** Jeffrey S. Obert, et al. **Examiner:** S. Ahmed
 Serial No: 09/888,975 **Group Art Unit:** 1765
 Filing Date: June 22, 2001 **Confirmation No:** 9544
 Title: Slotted Substrate And Slotting Process

10 **To:** Commissioner of Patents and Trademarks
 PO Box 1450
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15 **From:** Robert Sismilich
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AMENDMENT

20 In response to the "Notice of Non-Compliant Amendment" dated
 September 9, 2003, a compliant "Amendments to the Claims" section is hereby
 submitted to replace the non-compliant section.